

规格书编号

SPEC NO:

# 产品规格书

# SPECIFICATION

CUSTOMER 客户: LG INNOTEK CO.,LTD

PRODUCT 产品: SAW FILTER

MODEL NO 型号: HDBF36A26F 2.3mm HF

PREPARED 编制: \_\_\_\_\_ CHECKED 审核: \_\_\_\_\_

APPROVED 批准: \_\_\_\_\_ D A T E 日期: 2012-4-26

客户确认 CUSTOMER RECEIVED:		
审核 CHECKED	批准 APPROVED	日期 DATE

无锡市好达电子有限公司  
Shoulder Electronics Limited

**更改历史记录**  
**History Record**

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型 号 Customer No.	更改内容描述 Modify Content	备注 Remark

**1. SCOPE**

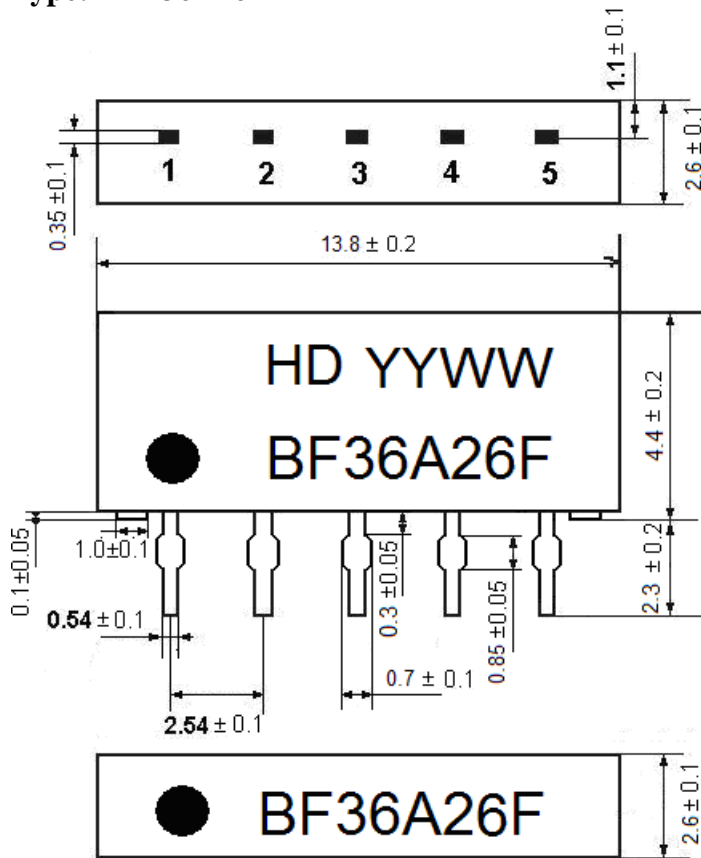
Bandpass filter for digital TV applications

**2. Construction**

**2.1 Dimension and materials**

Manufacturer's name: SHOULDER ELECTRONICS Co. LTD (CHINA)

Type: BF36A26F



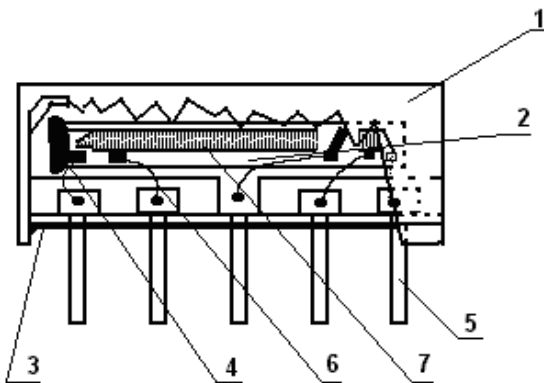
UNIT: mm

PIN configuration

- 1. Input
- 2. Input ground
- 3. Chip-carrier ground
- 4. Output
- 5. Output

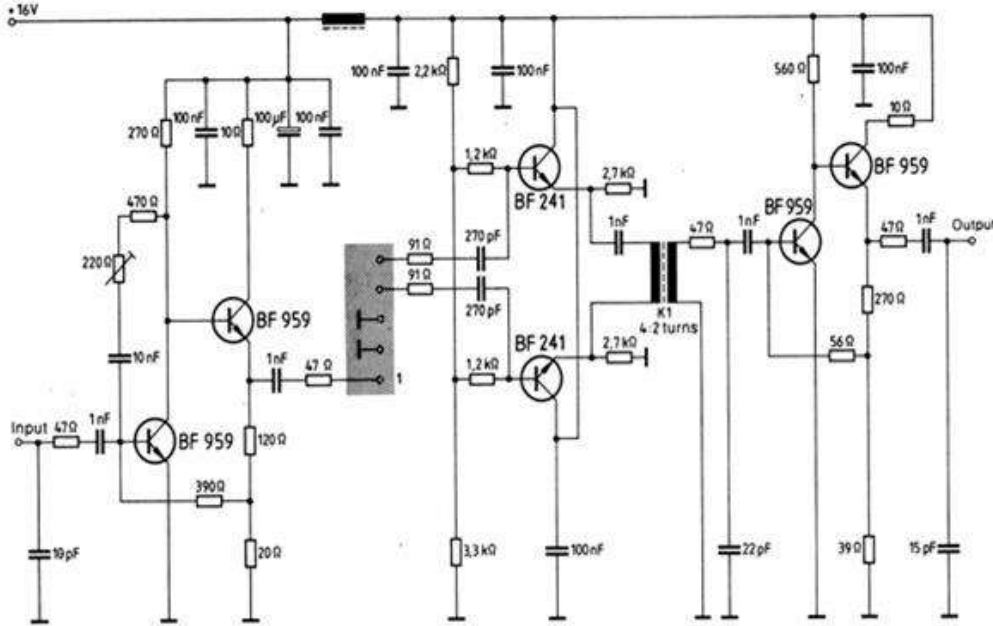
YY: year

WW: week



Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+ Ni plate+ Sn enameled
6.Bonding wire	AlSi alloy
7.Electrode	Al

**2.2. Circuit construction, measurement circuit**



Test circuit for SIP-5 filter  
 Input impedance of the symmetrical post-amplifier: 2 kΩ in parallel with 3 pF

**3. Characteristics**

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	There shall be no damage.
Operating temperature range	Operating temperature range is the range of ambient temperatures in which the filter can be operated continuously. -20°C ~ +60°C	
Storage temperature range	Storage temperature range is the range of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. -40°C ~ +70°C	
Reference temperature	+25°C	

**3.1 Maximum Rating**

<b>DC voltage</b>	<b>VDC</b>	<b>12</b>	<b>V</b>	<b>Between any terminals</b>
<b>AC voltage</b>	<b>Vpp</b>	<b>10</b>	<b>V</b>	<b>Between any terminals</b>

**3.2 Electrical Characteristics**

Source impedance

$Z_s=50\ \Omega$

Load impedance

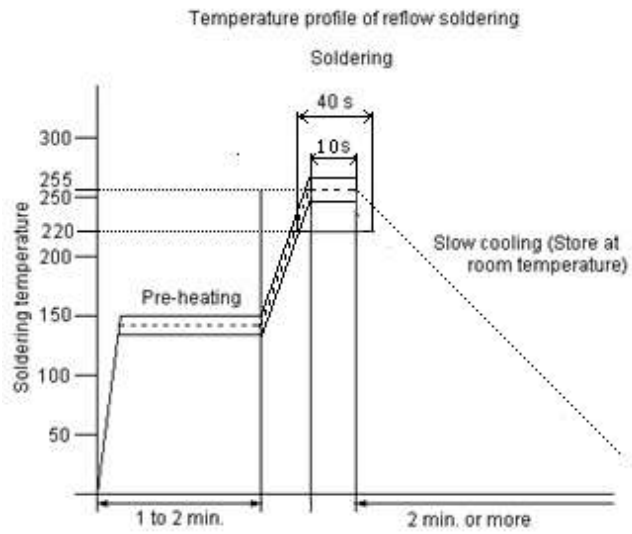
$Z_L=2k\ \Omega //3pF$

$T_A=25^\circ C$

Item	Freq	min	typ	max	
<b>Center frequency</b>	Fo	36.00	36.125	36.25	MHz
<b>Insertion attenuation</b> Reference level	36.125MHz	19.3	20.8	22.3	dB
Amplitude ripple(p-p) (32.7~39.5MHz)		-	0.5	0.8	dB
Pass bandwidth	B3dB	7.4	7.7	8.0	MHz
	B15dB	8.2	8.5	8.8	MHz
Relative attenuation	30.750MHz	40.0	50.0	-	dB
	30.875MHz	40.0	50.0	-	dB
	40.250MHz	13.0	17.0	-	dB
	40.375MHz	23.0	31.0	-	dB
<b>Sidelobe</b>	25.00~30.75MHz	36.0	40.0	-	dB
	40.50~42.50MHz	24.0	31.0	-	dB
	42.50~45.00MHz	35.0	41.0	-	dB
<b>Reflected wave signal suppression</b> 1.2 us ... 6.0 us after main pulse (test pulse 250 ns , carrier frequency 36.125 MHz)		42.0	50.0	-	dB
<b>Feedthrough signal suppression</b> 1.3us...1.2us before main pulse (test pulse 250 ns , carrier frequency 36.00 MHz)		42.0	60.0	-	dB
<b>Group delay ripple</b> (p-p) 32.3 ~40.0 MHz		-	35.0	80.0	ns
<b>Temperature coefficient</b>		-72			ppm/K

**3.3 Environmental Performance Characteristics**

Item	Condition	Specifications
High temperature	The specimen shall be store at a temperature of 80±2°C for 96±4h. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.	

Low temperature	The specimen shall be store at a temperature of $-20\pm 3^{\circ}\text{C}$ for $96\pm 4\text{h}$ . Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.	Mechanical characteristics and specifications in electrical characteristics shall be satisfied. There shall be no excessive change in appearance.								
Humidity	The specimen shall be store at a temperature of $40\pm 2^{\circ}\text{C}$ with relative humidity of 90% to 96% for $96\pm 4\text{h}$ . Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.									
Thermal shock	<p>The specimen shall be subjected to 100 continuous cycles each as shown below. Then it shall be subjected to standard atmospheric conditions for 1h, after which measurement shall be made within 1h.</p> <table border="1" data-bbox="384 741 954 875"> <thead> <tr> <th></th> <th>Temperature</th> <th>Duration</th> </tr> </thead> <tbody> <tr> <td>1</td> <td><math>-40^{\circ}\text{C}</math></td> <td>0.5h</td> </tr> <tr> <td>2</td> <td><math>+85^{\circ}\text{C}</math></td> <td>0.5h</td> </tr> </tbody> </table>			Temperature	Duration	1	$-40^{\circ}\text{C}$	0.5h	2	$+85^{\circ}\text{C}$
	Temperature	Duration								
1	$-40^{\circ}\text{C}$	0.5h								
2	$+85^{\circ}\text{C}$	0.5h								
Resistance to Soldering heat	<p>Reflow soldering method for lead and body            Peak: <math>255 \pm 5^{\circ}\text{C}</math> for ROHS            At electrode temperature of the specimen.</p> <div data-bbox="384 1025 1018 1556" data-label="Figure">  <p>The graph shows the temperature profile for reflow soldering. The y-axis is 'Soldering temperature' ranging from 50 to 300. The x-axis shows time intervals: '1 to 2 min.' for pre-heating, '40 s' for the soldering peak, and '2 min. or more' for slow cooling. The pre-heating phase reaches a plateau at 150°C. The soldering phase has a peak at 255°C with a 10s dwell time. The cooling phase is labeled 'Slow cooling (Store at room temperature)'.</p> </div> <p>The specimen shall be passed through the reflow furnace with the condition shown in the above profile for 1 time.</p> <p>The specimen shall be stored at standard atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be 1.6 mm thick. Base material shall be glass fabric base epoxy resin.</p>									
Solder ability	Immerse the pins melt solder at $260^{\circ}\text{C}+5/-0^{\circ}\text{C}$ for 5 sec.	More then 95% of total area of the pins should be covered with solder								

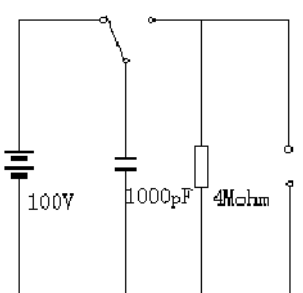
The reliability test result as below:

Test Name	Test Condition	Test Sample Q'ty	Test Result	
			PASS	NG.
<b>HDBF36A26F</b>				
	<b>High temperature test</b>	30Pcs	30Pcs	
	80±2°C for 96±4h			
	<b>Low temperature test</b>	30Pcs	30Pcs	
	-20±3°C for 96±4h			
	<b>Humidity Test</b>	30Pcs	30Pcs	
	40±2°C 90% to 96% for 96±4h			
	<b>Thermal shock</b>	30Pcs	30Pcs	
	-40°C/30min~+85°C/30min 100cycle			
	<b>Soldering heat</b>	30Pcs	30Pcs	
	255 ±5 °C, 220 ±5 °C, for 5 sec			
	<b>Solderability</b>	30Pcs	30Pcs	
	Immerse the melt solder at 260°C+5/-0°C for 5 sec. Surface of the pins shall be covered with solder sufficiently.			

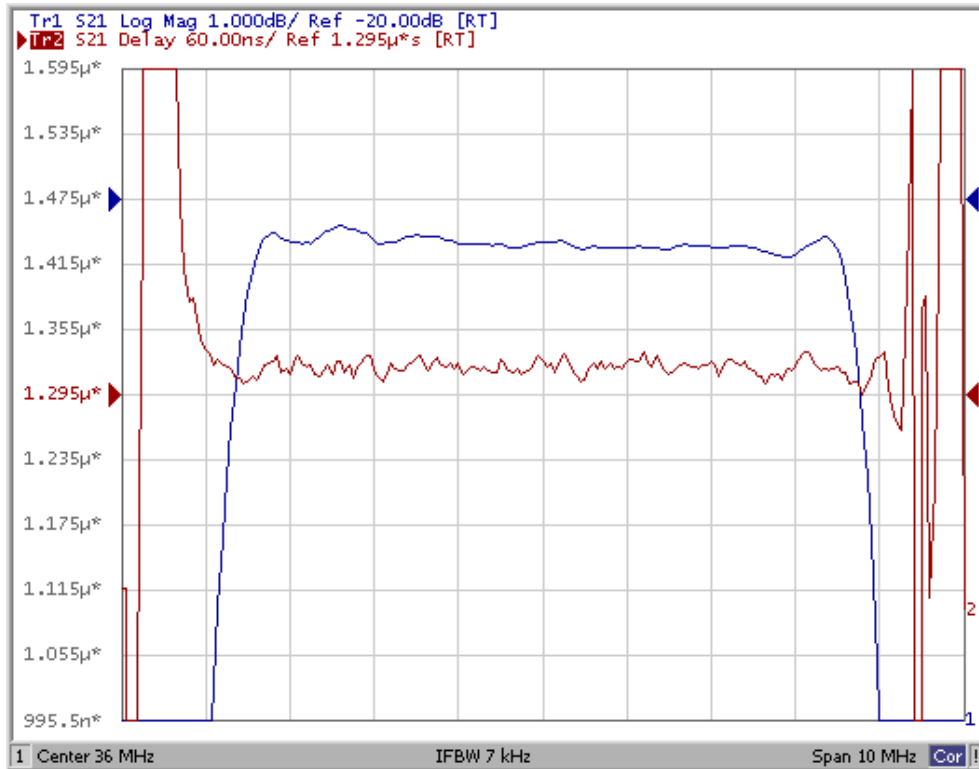
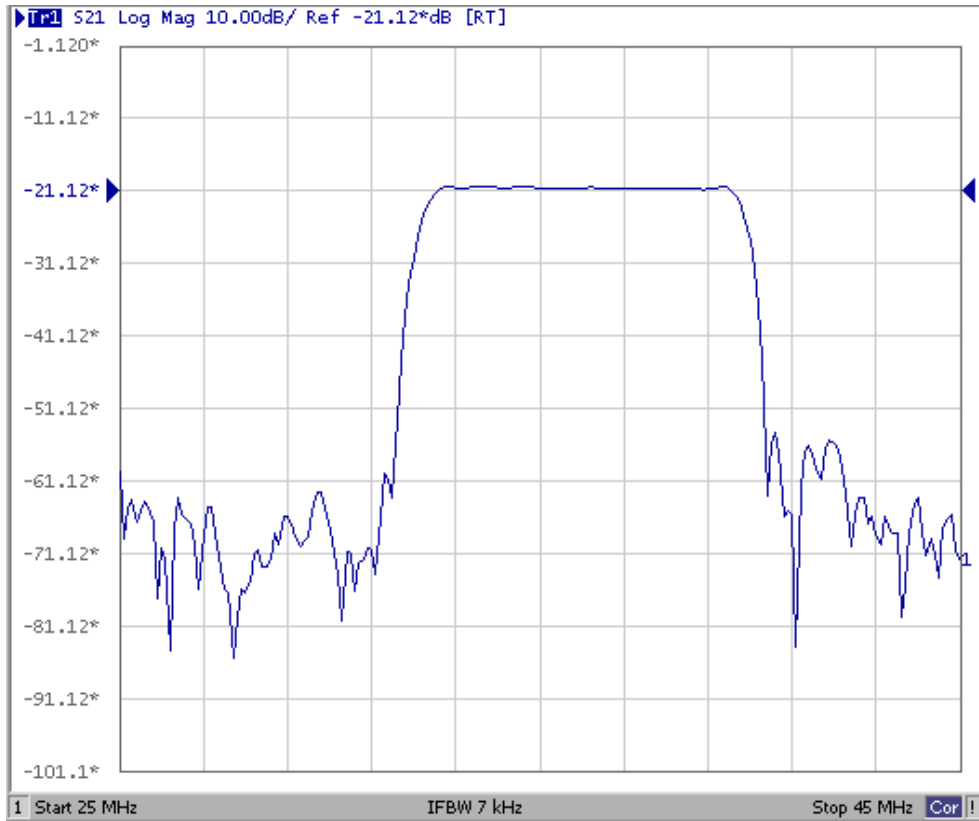
### 3.4 Mechanical Test

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm 3 directions 2 H each	There shall be no damage.
Drop	On maple plate from 1 m high 3 times	
Lead pull	Pull with 1 kg force for 30 seconds	
Lead bend	90° bending with 500g weigh 2 times	

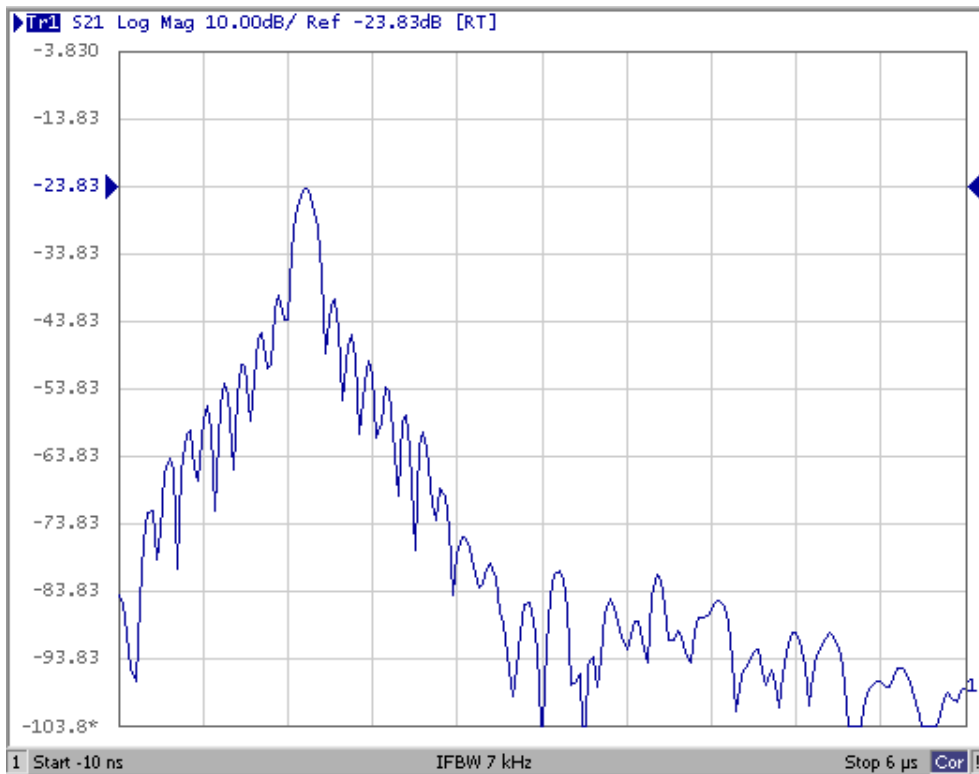
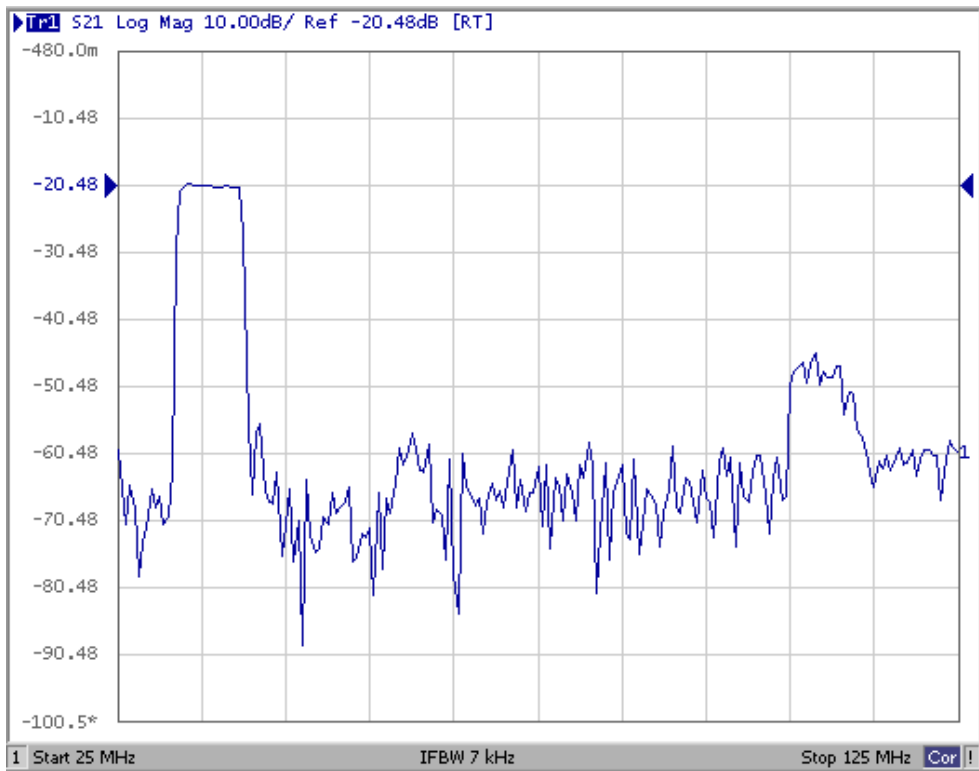
### 3.5 Voltage Discharge Test

Item	Condition	Specifications
Surge	Between any two electrode 	There shall be no damage

3.6 Frequency response:





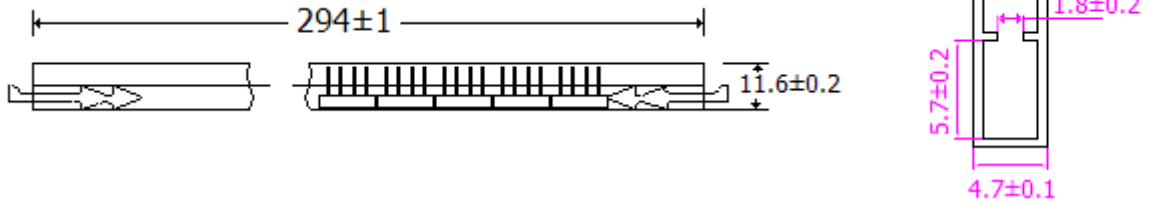


**3.7package**

Unit: mm

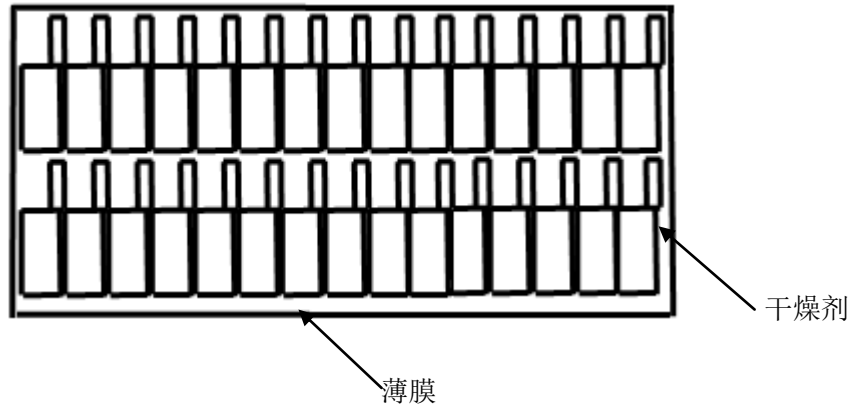
**Pipe**

20PCS /pipe



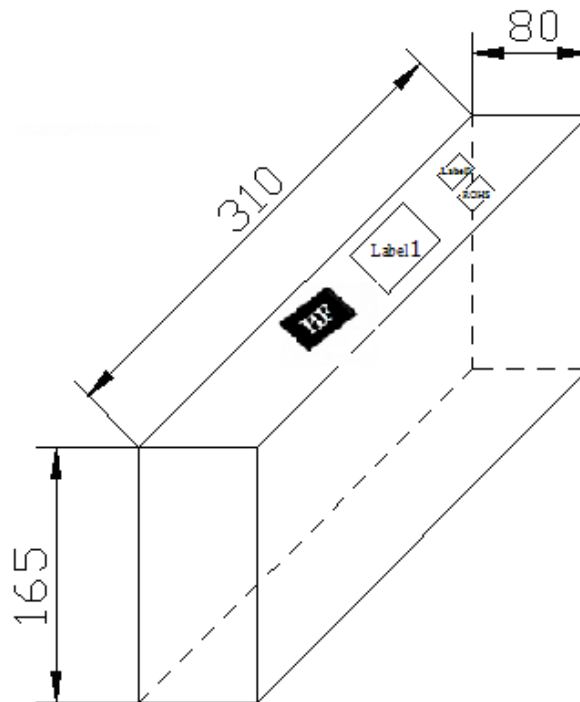
**Pipes**

20×30PCS



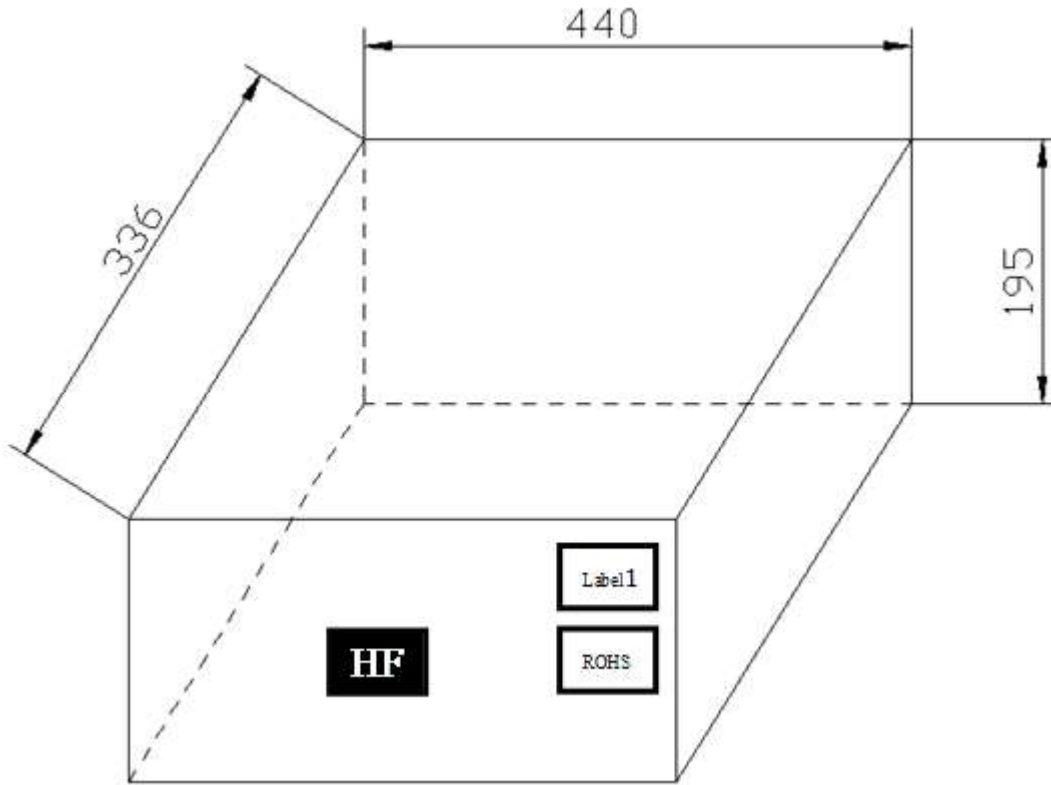
**Inside Box**

600×5PCS



**Outside Box**

3000×5PCS




Label 2:

HDBF36A26F  
3000PCS

Label 1:

ROHS

Vendor Name	SHOULDER ELECTORNICS LTD	
		
Item No	2FS3890..... (LGIT CODE)	
Qty	15000PCS	
Lot No		

**ROHS:**



**HF:**

